



APPROVAL SHEET
FOR
MICROPHONE

深 圳 市 銳 創 達 電 子 有 限 公 司

TAT ELECTRONICS CO. LTD.

CUSTOMER: 比特

PART NUMBER: **EM9767-38dB** 加 **12V** 稳压管

CUSTOMER PART NO.: **M163138113110**

CUSTOMER	APPROVED	CHECKED
	钟云莎	郑飞
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Model No.:	EM9767-38dB	Li YanFei	Jiang Yin
		11/11/2025	11/11/2025

1. Scope

The specifications should be applied to electret condenser microphone of DGOB4015DD(-P)C1033

2. Storage And Judgement Conditions

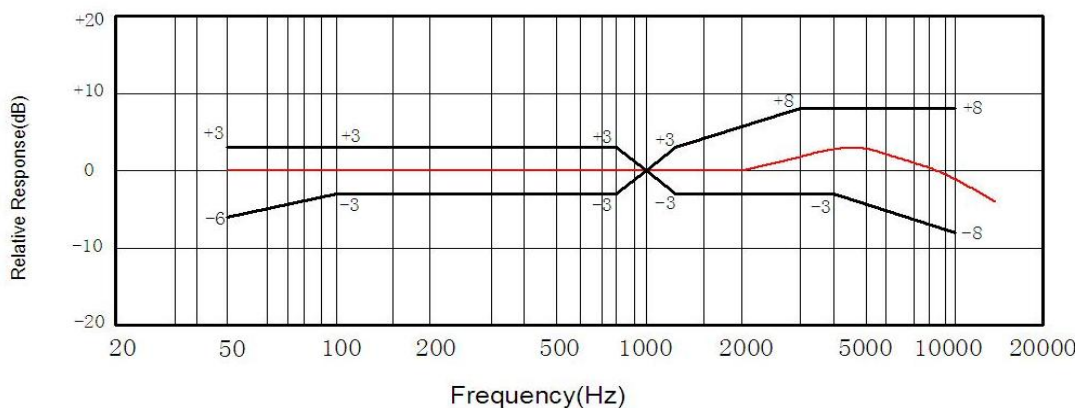
	Temperature Range(° C)	Rel. Humidity (%)	Static Pressure (kPa)
Judgement	19~21	60~70	86~106
Storage	-40~80		
Operating	-20~70		

3. Specifications

Test Conditions: $V_s=2.0V$, $R_L=2.2K\Omega$, $Temp=20\pm2^\circ C$, $R.H=60\pm5\%$

ITEM	Symbol	Test Conditions	Min	Standard	Max	Unit
Sensitivity	S	$f=1KHz$, S. P. L=1Pa	-40	-38	-36	dB 0dB=1V/Pa
Impedance	Z	$f=1KHz$, S. P. L=1 μ Bar			2.2	K Ω
Directivity		Omni-directional				
Current Consumption	I		50		500	μA
Operation Voltage Range	V_s		1.0	4.5	10	V
S/N Ratio	S/N(A)	$f=1KHz$, S. P. L=1Pa A Curve	55			dB
Decreasing Voltage Characteristic	ΔS	$f=1KHz$, S. P. L=1Pa $V_s=1.5-1.0V$			-3	dB
Max. Input Sound Level	MISPL	$f=1KHz$, Distortion $\leq 3\%$			115	dB

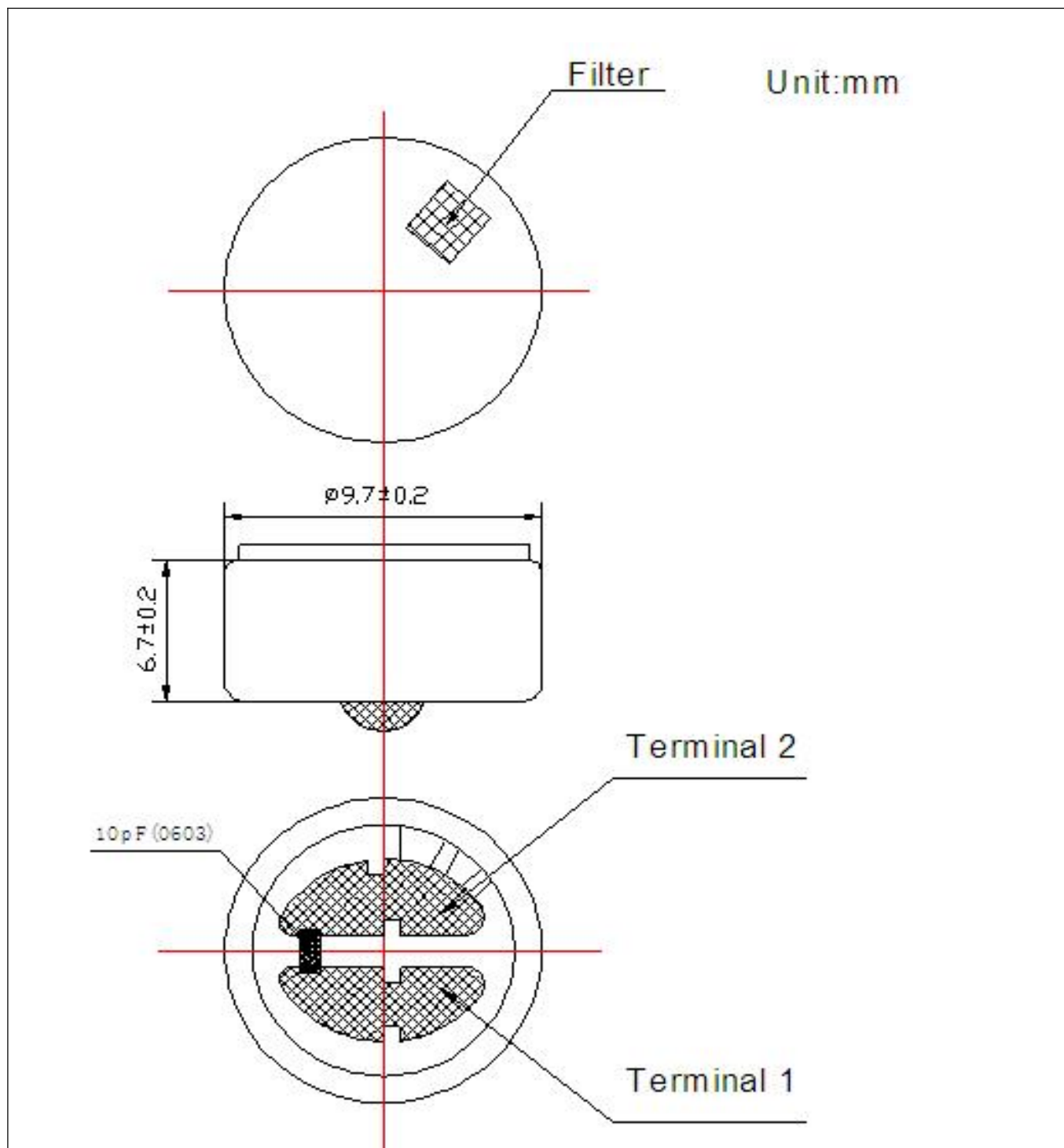
4. Frequency Response





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5. APPEARANCE & DIMENSIONS



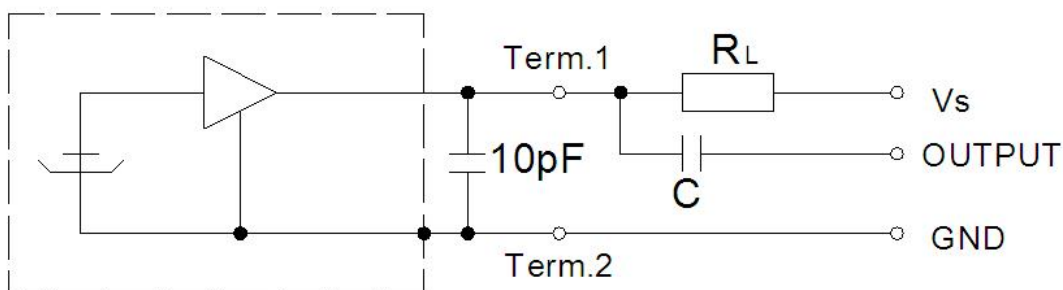


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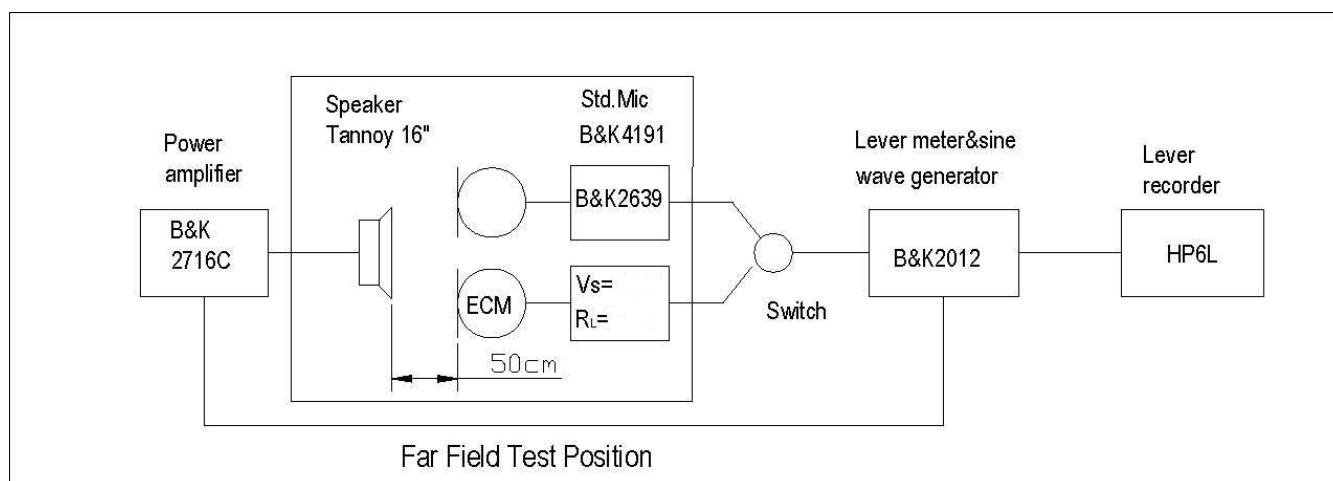
6. Test Circuit

Measurement Circuit

Vs: Source Voltage 4.5V RL: Load Resistance 2.2KΩ



7. Test Setup Drawing



Vs=4.5V

RL=2.2kΩ



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8. Reliability Test

All tests should be done after 2 hours of conditioning at 20°C, R. H65% , while the sensitivity is to be within $\pm 3\text{dB}$ from the initial sensitivity after the following experiments.

8.1 High Temperature Test

High temperature:	+60°C
Duration:	72 hours

8.2 Low Temperature Test

Low temperature:	-40°C
Duration:	72 hours

8.3 Temperature Cycle Test (See in Fig.1)

Low temperature:	-25°C
High temperature:	+60°C
Changeover time:	10min
Duration:	30min
Cycle:	32

8.4 Statical Humidity Test

Temperature:	+40°C
Relative humidity:	90~95%
Duration:	72hours



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8.5 Vibration Test

Amplitude :	1.52mm
Duration:	1minutes /plane
Freq.range:	10~55 Hz
Total time:	2 hours

8.6 Dropping Test

Drop a unit unpacked onto a board of 20mm thick.

Height:	1.0 m
Cycle:	6

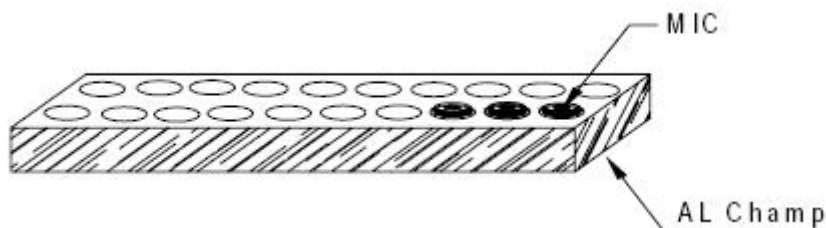
8.7 ESD Test

The microphone under test must be discharged between each ESD exposure without ground.

(contact: $\pm 6KV$, air: $\pm 8KV$) There is no interference in operation after 10 times exposure.

9. Regarding the Soldering operation

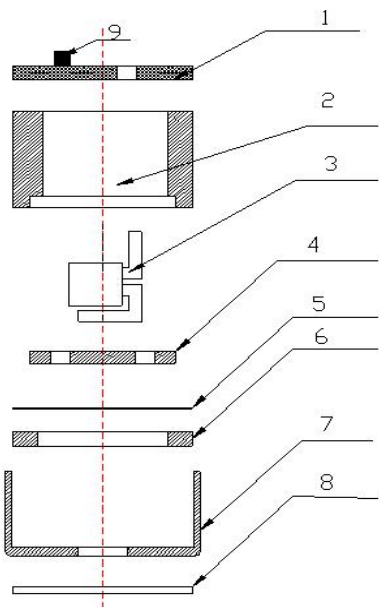
- Use 15~20W soldering iron and maintain $290^{\circ}C \sim 310^{\circ}C$ in operation.
- Operators who work in the solder fixture and the soldering iron must be statically grounded under each soldering process.
- Soldering should be accomplished within two seconds at each terminal so as not to be overheated.
- Optimal design for heat sink pad is same as below.





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10. List and Structure of Materials



NO.	PARTS
1	PCB
2	Holder
3	FET
4	Back plate
5	Spacer
6	Film
7	Outer most shell
8	Protection fleece
9	Capacitor

NO	Part name	Material Type	Qty	Origin	Manufacture	Remarks
1	PCB	FR-1	1			
2	Holder	ABS	1			
3	FET	K596	1			
4	Back plate	Cu	1			
5	Spacer	Mylar	1			
6	Film	FEP	1			
7	Outer most shell	AL	1			
8	Protection fleece	Fabrics	1			
9	Capacitor	0603 10pF	1			

1、Assembly process

- After connector and holder are once disassembled, they should not be re-used.
- Do not touch outer springs directly (except for PCB or proper terminal set at nominal height).



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c)、Do not give any mechanical shocks to the microphone(e.g. dropping to floor)

2、General information

2-1: This microphone shall not be operated or stored in following environment.

>where liquid(water,solvent and so on)splashes.

>where the air has a high concentration of corrosive gas .

>where is too dusty.

>where temperature changes rapidly.

2-2: Frequency response especially in high frequency region is dependent on the structure of enclosure.

Please remove additional acoustic mass or cavity in front of the microphone to the utmost.

2-3:do not put mechanical pressure more than 2 kg to the microphone.

2-4: microphone should not be in state of outgoing packing for a long-term storage.

2-5: all the soldering procedures upon microphone must be complete in a metallic device,the temperature of the soldering irons must be limited as 320℃ and less 3 s ,the operators、 the solder fixtures and the soldering irons must be statically grounded under each soldering process.